

Complementary MOSFET

ELM34604AA-N

■General Description

ELM34604AA-N uses advanced trench technology to provide excellent $R_{ds(on)}$ and low gate charge.

■Features

N-channel	P-channel
• $V_{ds}=40V$	$V_{ds}=-40V$
• $I_d=7A$	$I_d=-5A$
• $R_{ds(on)} < 28m\Omega(V_{gs}=10V)$	$R_{ds(on)} < 65m\Omega(V_{gs}=-10V)$
• $R_{ds(on)} < 42m\Omega(V_{gs}=4.5V)$	$R_{ds(on)} < 105m\Omega(V_{gs}=-4.5V)$

■Maximum Absolute Ratings

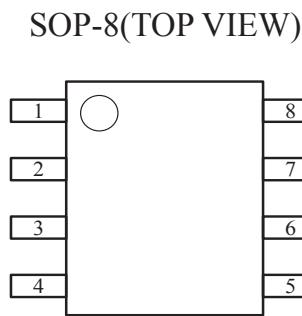
Ta=25°C. Unless otherwise noted.

Parameter	Symbol	N-ch (Max.)	P-ch (Max.)	Unit	Note
Drain-source voltage	V_{ds}	40	-40	V	
Gate-source voltage	V_{gs}	± 20	± 20	V	
Continuous drain current	Id	7	-6	A	
		6	-5		
Pulsed drain current	I_{dm}	20	-20	A	3
Power dissipation	Pd	2.0	2.0	W	
		1.3	1.3		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	-55 to 150	°C	

■Thermal Characteristics

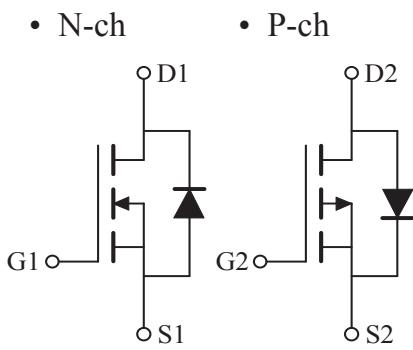
Parameter	Symbol	Device	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$R_{\theta ja}$	N-ch		62.5	°C/W	
Maximum junction-to-ambient	$R_{\theta ja}$	P-ch		62.5	°C/W	

■Pin configuration



Pin No.	Pin name
1	SOURCE1
2	GATE1
3	SOURCE2
4	GATE2
5	DRAIN2
6	DRAIN2
7	DRAIN1
8	DRAIN1

■Circuit



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■Electrical Characteristics (N-ch)

Ta=25°C. Unless otherwise noted.

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit	Note
STATIC PARAMETERS							
Drain-source breakdown voltage	BVdss	Id=250µA, Vgs=0V	40			V	
Zero gate voltage drain current	Idss	Vds=32V, Vgs=0V			1	µA	
		Vds=30V, Vgs=0V, Ta=55°C			10		
Gate-body leakage current	Igss	Vds=0V, Vgs=±20V			±100	nA	
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=250µA	1.0	1.5	2.5	V	
On state drain current	Id(on)	Vgs=10V, Vds=5V	20			A	1
Static drain-source on-resistance	Rds(on)	Vgs=10V, Id=7A		21	28	mΩ	1
		Vgs=4.5V, Id=6A		30	42		
Forward transconductance	Gfs	Vds=10V, Id=7A		19		S	1
Diode forward voltage	Vsd	If=Is, Vgs=0V			1	V	1
Max.body-diode continuous current	Is				1.3	A	
Pulsed current	Ism				2.6	A	3
DYNAMIC PARAMETERS							
Input capacitance	Ciss	Vgs=0V, Vds=10V, f=1MHz		790		pF	
Output capacitance	Coss			175		pF	
Reverse transfer capacitance	Crss			65		pF	
SWITCHING PARAMETERS							
Total gate charge	Qg	Vgs=10V, Vds=20V, Id=7A		16.0		nC	2
Gate-source charge	Qgs			2.5		nC	2
Gate-drain charge	Qgd			2.1		nC	2
Turn-on delay time	td(on)	Vgs=10V, Vds=20V, Id=1A Rgen=6Ω		2.2	4.4	ns	2
Turn-on rise time	tr			7.5	15.0	ns	2
Turn-off delay time	td(off)			11.8	21.3	ns	2
Turn-off fall time	tf			3.7	7.4	ns	2

NOTE :

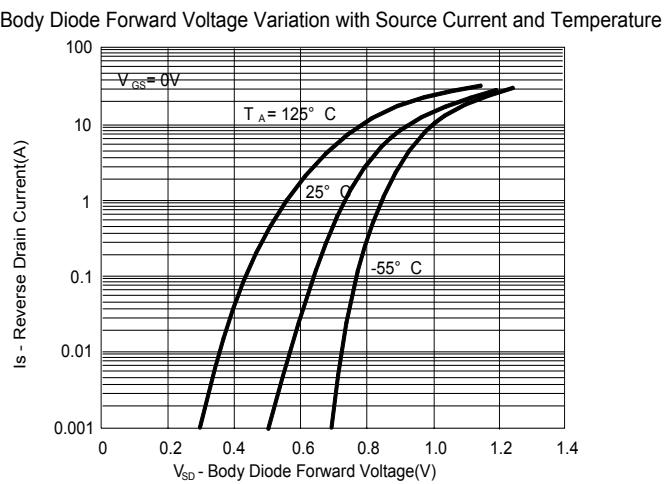
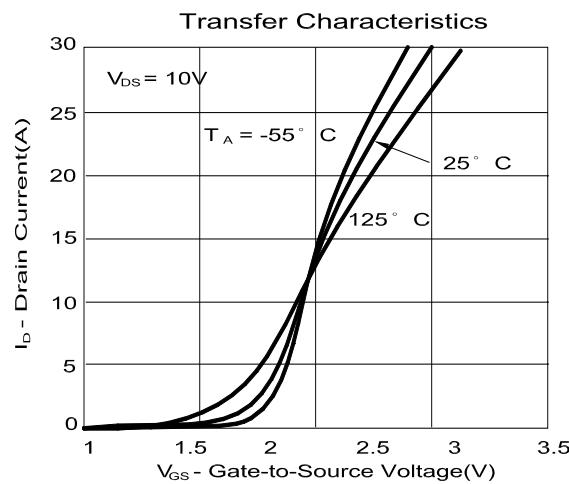
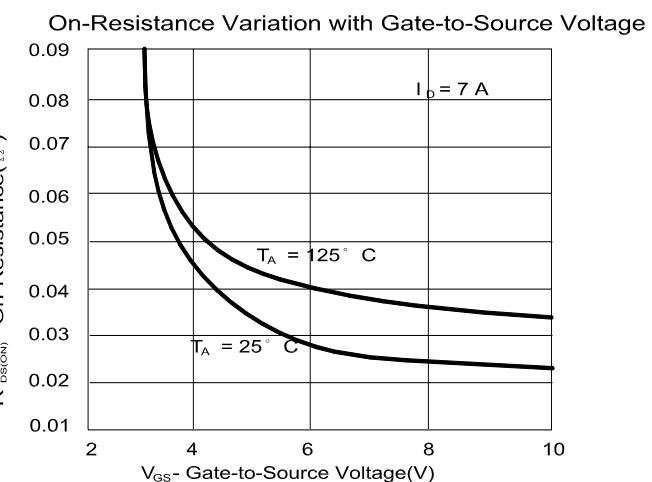
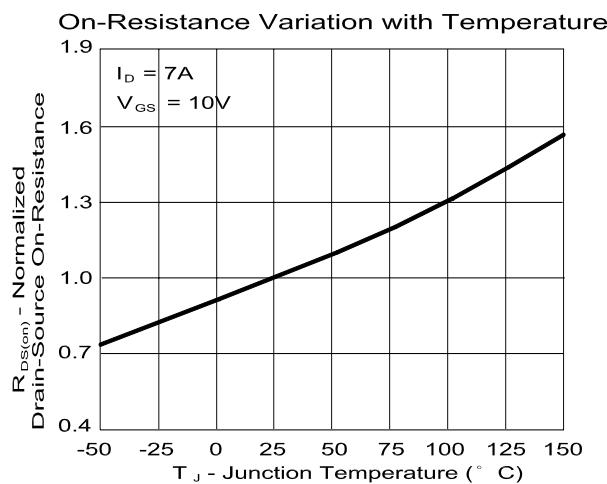
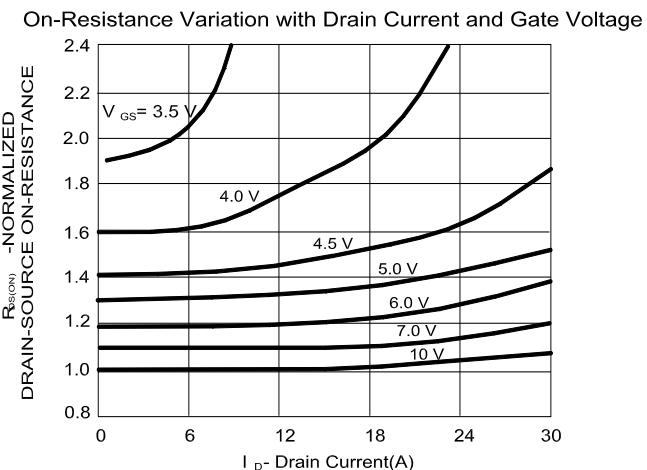
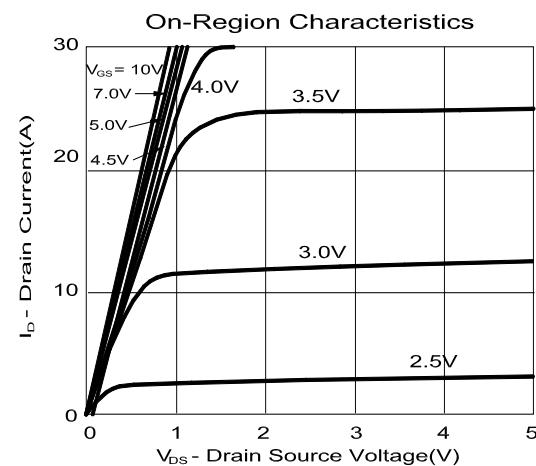
1. Pulse test : Pulsed width≤300µsec and Duty cycle≤2%.
2. Independent of operating temperature.
3. Pulsed width limited by maximum junction temperature.
4. Duty cycle ≤ 1%.



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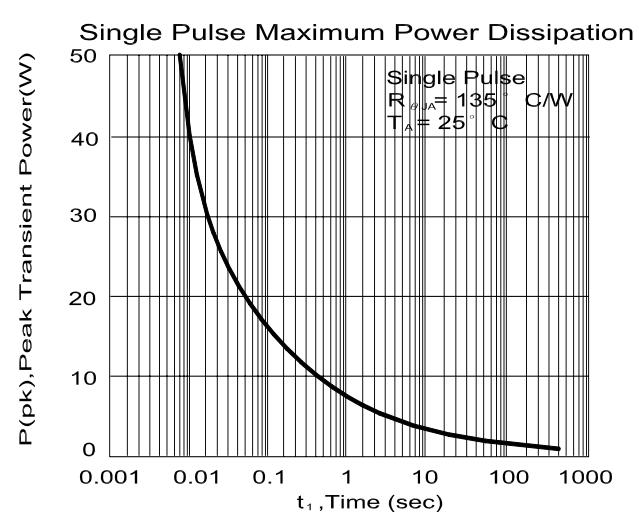
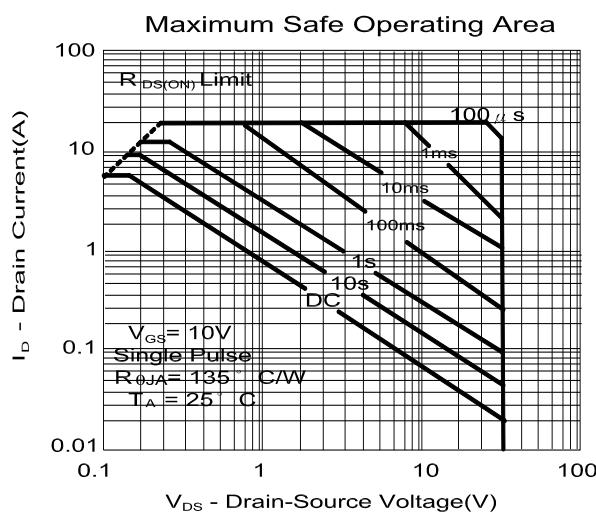
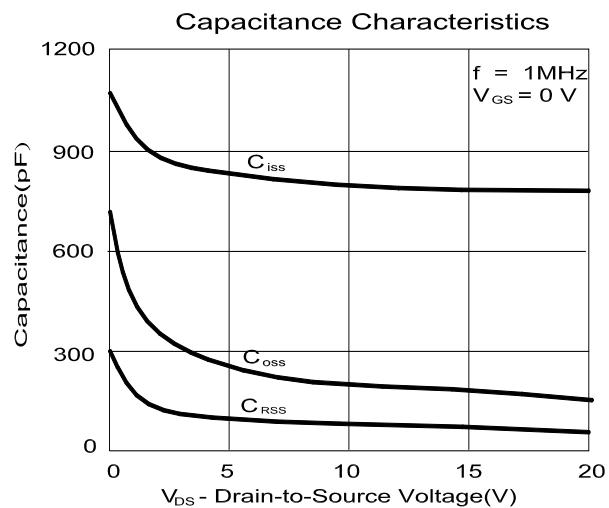
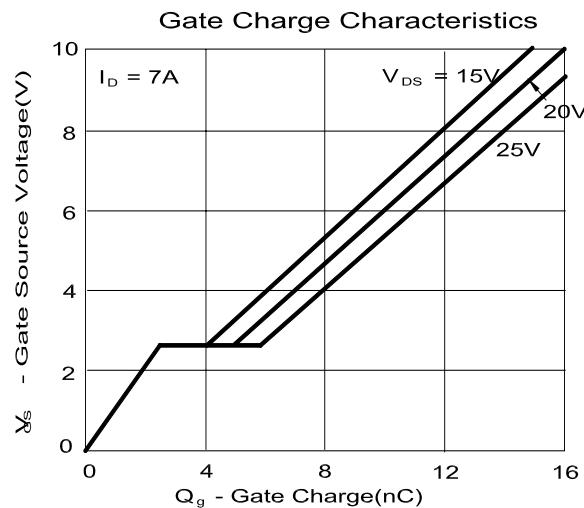
ELM34604AA-N

■ Typical Electrical and Thermal Characteristics (N-ch)



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■Electrical Characteristics (P-ch)

T_a=25°C. Unless otherwise noted.

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit	Note
STATIC PARAMETERS							
Drain-source breakdown voltage	BV _{dss}	I _d =-250μA, V _{gs} =0V	-40			V	
Zero gate voltage drain current	I _{dss}	V _{ds} =-32V, V _{gs} =0V			-1	μA	
		V _{ds} =-30V, V _{gs} =0V, T _a =55°C			-10		
Gate-body leakage current	I _{gss}	V _{ds} =0V, V _{gs} =±20V			±100	nA	
Gate threshold voltage	V _{gs(th)}	V _{ds} =V _{gs} , I _d =-250μA	-1.0	-1.5	-2.5	V	
On state drain current	I _{d(on)}	V _{gs} =-10V, V _{ds} =-5V	-20			A	1
Static drain-source on-resistance	R _{ds(on)}	V _{gs} =-10V, I _d =-5A		50	65	mΩ	1
		V _{gs} =-4.5V, I _d =-4A		80	105		
Forward transconductance	G _{fs}	V _{ds} =-10V, I _d =-5A		11		S	1
Diode forward voltage	V _{sd}	I _f =I _s , V _{gs} =0V			-1	V	1
Max.body-diode continuous current	I _s				-1.3	A	
Pulsed current	I _{sm}				-2.6	A	3
DYNAMIC PARAMETERS							
Input capacitance	C _{iss}	V _{gs} =0V, V _{ds} =-10V, f=1MHz		690		pF	
Output capacitance	C _{oss}			310		pF	
Reverse transfer capacitance	C _{rss}			75		pF	
SWITCHING PARAMETERS							
Total gate charge	Q _g	V _{gs} =-10V, V _{ds} =-20V I _d =-5A		14.0		nC	2
Gate-source charge	Q _{gs}			2.2		nC	2
Gate-drain charge	Q _{gd}			1.9		nC	2
Turn-on delay time	t _{d(on)}	V _{gs} =-10V, V _{ds} =-20V I _d =-1A, R _L =1Ω, R _{gen} =6Ω		6.7	13.4	ns	2
Turn-on rise time	t _r			9.7	19.4	ns	2
Turn-off delay time	t _{d(off)}			19.8	35.6	ns	2
Turn-off fall time	t _f			12.3	22.2	ns	2

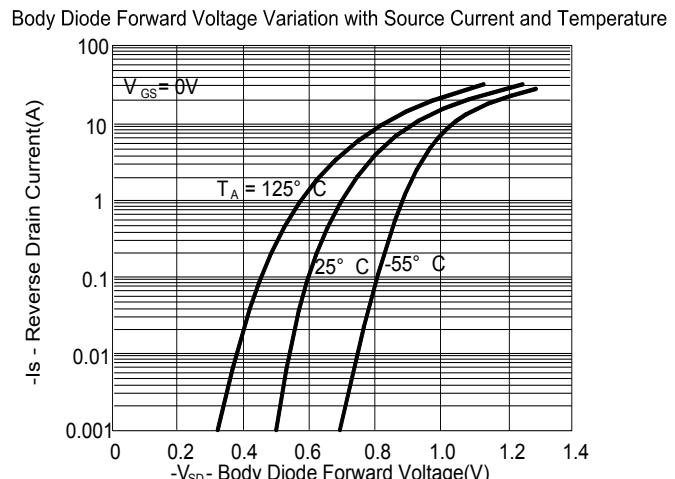
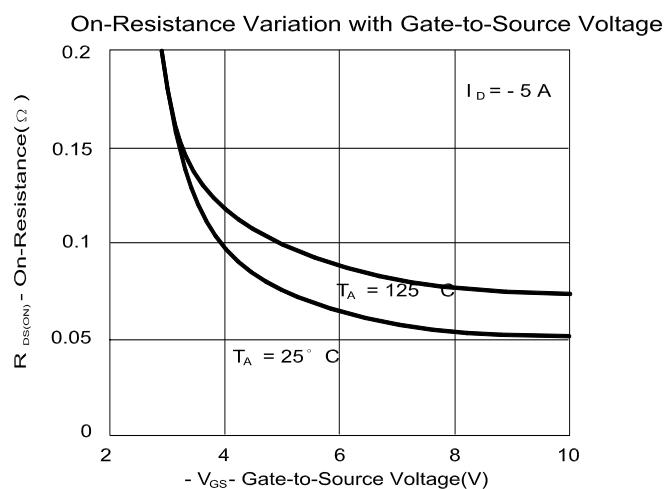
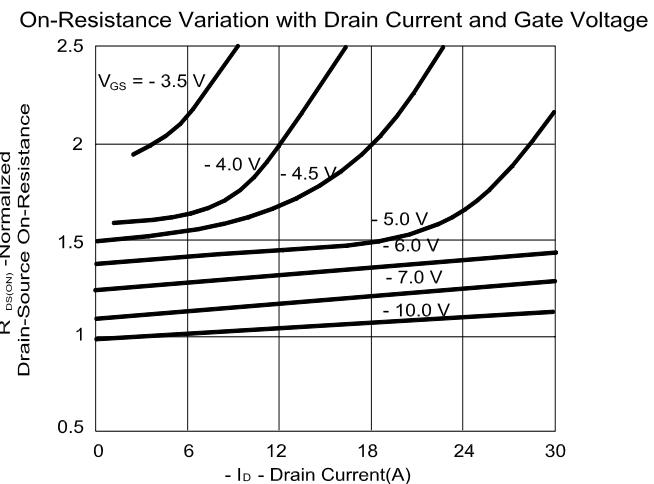
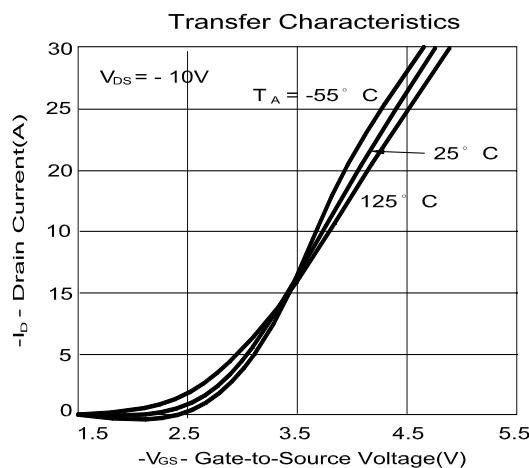
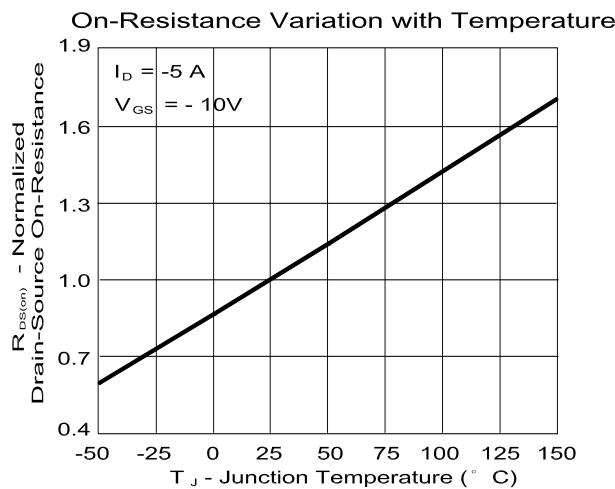
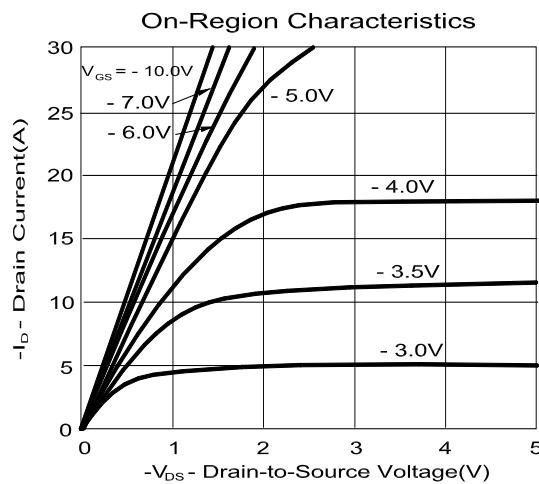
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2. Independent of operating temperature.
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